

Electronic Patent Application Fee Transmittal				
Application Number:	10595303			
Filing Date:	19-May-2006			
Title of Invention:	Method and Device For Secure, Insulated and Electrically Conductive Assembling Of Treated Semiconductor Wafers			
First Named Inventor/Applicant Name:	Roy Knechtel			
Filer:	Yisun Song/Robin Taylor			
Attorney Docket Number:	60291.000048			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$0 paid	1252	1	490	490

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				1300